



St. Paul's School (Lam Tin)
10 On Tin Street, Lam Tin, Kowloon.

Application for admission to Form Six (SCIENCE) 2009-2010

Name (English): _____
(Surname) (other names) (Christian name)

(Chinese): _____ F.5 _____ Class No.: _____ HKCEE No.: _____

Tel. No. : _____ (Mobile) _____ (Home)

The following is the combination of the Sixth Form subjects for the years 2009-2010.

Compulsory Subjects: English, Chinese, R.K., P.E., Chemistry and Physics

Electives: (You may opt for 1AL)

Level	Subjects	1 st Preference	2 nd Preference
AL	Pure Mathematics / Biology		

Date: _____

Signature of Applicant: _____

Declaration:

I understand that once I accept a Form 6 place in the School, my F.6 Admission Slip will **NOT** be returned to me before September 2009. If I obtained Level 1 in Chinese Language or/and English Language, I will sit for HKCEE of the relevant subject(s) within 18 months.

Signature of Applicant: _____



St. Paul's School (Lam Tin)
10 On Tin Street, Lam Tin, Kowloon.

Application for admission to Form Six (ARTS) 2009-2010

Name (English): _____
(Surname) (other names) (Christian name)

(Chinese): _____ F.5 _____ Class No.: _____ HKCEE No.: _____

Tel. No. : _____ (Mobile) _____ (Home)

The following is the combination of the Sixth Form subjects for the years 2009-2010.

Compulsory Subjects: English, Chinese, R.K., P.E.,
Electives: (You may opt for 3AL or 2AL + 2AS or 2AL + 1AS)

Subjects *	e.g.	Preference				
		1	2	3	4	5
GPA / POA I / Econ. I / Maths. & Stat. (AS)	POA I					
POA II / Geography I / History	Geog I					
Econ. II / Eng. Literature / Chin. History	Econ. II					
Chin. Literature / Geography II / Liberal Studies (AS)	/					

* All are AL subjects unless specified.

Date: _____

Signature of Applicant: _____

Declaration :

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